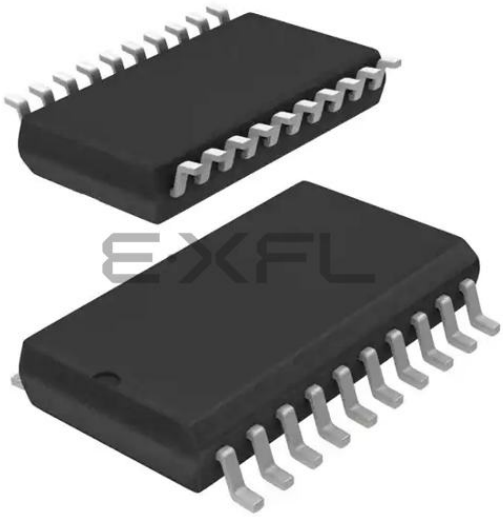

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	5MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	16
Program Memory Size	2KB (2K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0213sh005sc

CPU and Peripheral Overview

eZ8 CPU Features

The eZ8 CPU, Zilog's latest 8-bit central processing unit (CPU), meets the continuing demand for faster and code-efficient microcontrollers. The eZ8 CPU executes a superset of the original Z8® instruction set. The eZ8 CPU features include:

- Direct register-to-register architecture allows each register to function as an accumulator, improving execution time and decreasing the required program memory.
- Software stack allows much greater depth in subroutine calls and interrupts than hardware stacks.
- Compatible with existing Z8 code.
- Expanded internal Register File allows access of up to 4 KB.
- New instructions improve execution efficiency for code developed using higher-level programming languages, including C.
- Pipelined instruction fetch and execution.
- New instructions for improved performance including BIT, BSWAP, BTJ, CPC, LDC, LDCI, LEA, MULT, and SRL.
- New instructions support 12-bit linear addressing of the Register file.
- Up to 10 MIPS operation.
- C-Compiler friendly.
- 2 to 9 clock cycles per instruction.

For more information on eZ8 CPU, refer to *eZ8 CPU Core User Manual (UM0128)* available for download at www.zilog.com.

General-Purpose I/O

Z8 Encore! XP F0823 Series features 6 to 24 port pins (Ports A–C) for general-purpose I/O (GPIO). The number of GPIO pins available is a function of package. Each pin is individually programmable. 5 V tolerant input pins are available on all I/Os on 8-pin devices, most I/Os on other package types.

Flash Controller

The Flash Controller programs and erases Flash memory. The Flash Controller supports protection against accidental program and erasure, as well as factory serialization and read protection.

Table 5 provides detailed information about the characteristics for each pin available on Z8 Encore! XP® F0823 Series 8-pin devices.

Note: *All six I/O pins on the 8-pin packages are 5 V-tolerant (unless the pull-up devices are enabled). The column in* Table 4 *below describes 5 V-tolerance for the 20- and 28-pin packages only.*

Table 4. Pin Characteristics (20- and 28-pin Devices)

Symbol Mnemonic	Direction	Reset Direction	Active Low or Active High	Tristate Output	Internal Pull-up or Pull-down	Schmitt-Trigger Input	Open Drain Output	5 V Tolerance
AVDD	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A
AVSS	N/A	N/A	N/A	N/A	N/A	N/A	N/A	NA
DBG	I/O	I	N/A	Yes	No	Yes	Yes	Yes
PA[7:0]	I/O	I	N/A	Yes	Programmable Pull-up	Yes	Yes, Programmable	PA[7:2] only
PB[7:0]	I/O	I	N/A	Yes	Programmable Pull-up	Yes	Yes, Programmable	PB[7:6] only
PC[7:0]	I/O	I	N/A	Yes	Programmable Pull-up	Yes	Yes, Programmable	PC[7:3] only
RESET	I/O	I/O (defaults to $\overline{\text{RESET}}$)	Low (in Reset mode)	Yes (PD0 only)	Always on for $\overline{\text{RESET}}$	Yes	Always on for $\overline{\text{RESET}}$	Yes
VDD	N/A	N/A	N/A	N/A			N/A	N/A
VSS	N/A	N/A	N/A	N/A			N/A	N/A

Note: *PB6 and PB7 are available only in the devices without ADC.*

Table 5. Pin Characteristics (8-Pin Devices)

Symbol Mnemonic	Direction	Reset Direction	Active Low or Active High	Tristate Output	Internal Pull-up or Pull-down	Schmitt-Trigger Input	Open Drain Output	5 V Tolerance
PA0/DBG	I/O	I (but can change during reset if key sequence detected)	N/A	Yes	Programmable Pull-up	Yes	Yes, Programmable	Yes, unless pull-ups enabled
PA1	I/O	I	N/A	Yes	Programmable Pull-up	Yes	Yes, Programmable	Yes, unless pull-ups enabled
$\overline{\text{RESET}}$/ PA2	I/O	I/O (defaults to $\overline{\text{RESET}}$)	N/A	Yes	Programmable for PA2; always on for $\overline{\text{RESET}}$	Yes	Programmable for PA2; always on for $\overline{\text{RESET}}$	Yes, unless pull-ups enabled
PA[5:3]	I/O	I	N/A	Yes	Programmable Pull-up	Yes	Yes, Programmable	Yes, unless pull-ups enabled
VDD	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A
VSS	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A

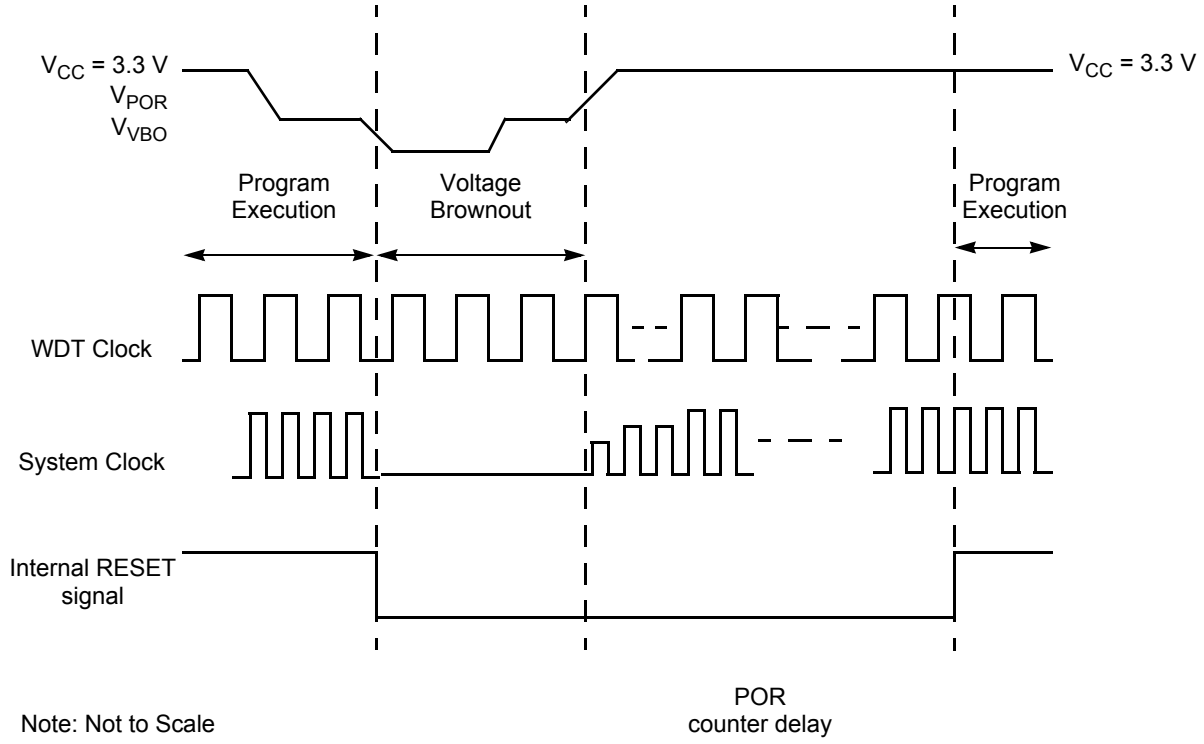


Figure 6. Voltage Brownout Reset Operation

The POR level is greater than the VBO level by the specified hysteresis value. This ensures that the device undergoes a POR after recovering from a VBO condition.

Watchdog Timer Reset

If the device is in NORMAL or STOP mode, the Watchdog Timer can initiate a System Reset at time-out if the WDT_RES Flash Option Bit is programmed to 1. This is the unprogrammed state of the WDT_RES Flash Option Bit. If the bit is programmed to 0, it configures the Watchdog Timer to cause an interrupt, not a System Reset, at time-out.

The WDT status bit in the WDT Control register is set to signify that the reset was initiated by the Watchdog Timer.

External Reset Input

The $\overline{\text{RESET}}$ pin has a Schmitt-Triggered input and an internal pull-up resistor. Once the $\overline{\text{RESET}}$ pin is asserted for a minimum of four system clock cycles, the device progresses through the System Reset sequence. Because of the possible asynchronicity of the system

Stop Mode Recovery Using the External $\overline{\text{RESET}}$ Pin

When the Z8 Encore! XP F0823 Series device is in STOP mode and the external $\overline{\text{RESET}}$ pin is driven Low, a system reset occurs. Because of a glitch filter operating on the $\overline{\text{RESET}}$ pin, the Low pulse must be greater than the minimum width specified, or it is ignored. For more details, see Electrical Characteristics on page 193.

Reset Register Definitions

Reset Status Register

The Reset Status (RSTSTAT) register is a read-only register that indicates the source of the most recent Reset event, indicates a Stop Mode Recovery event, and indicates a Watchdog Timer time-out. Reading this register resets the upper four bits to 0.

This register shares its address with the Watchdog Timer control register, which is write-only (Table 12).

Table 12. Reset Status Register (RSTSTAT)

BITS	7	6	5	4	3	2	1	0
FIELD	POR	STOP	WDT	EXT	Reserved			
RESET	See descriptions below			0	0	0	0	0
R/W	R	R	R	R	R	R	R	R
ADDR	FF0H							

Reset or Stop Mode Recovery Event	POR	STOP	WDT	EXT
Power-On Reset	1	0	0	0
Reset using $\overline{\text{RESET}}$ pin assertion	0	0	0	1
Reset using WDT time-out	0	0	1	0
Reset using the OCD (OCTCTL[1] set to 1)	1	0	0	0
Reset from STOP Mode using DBG Pin driven Low	1	0	0	0
Stop Mode Recovery using GPIO pin transition	0	1	0	0
Stop Mode Recovery using WDT time-out	0	1	1	0

POR—Power-On Reset Indicator
If this bit is set to 1, a Power-On Reset event is occurred. This bit is reset to 0 if a WDT time-out or Stop Mode Recovery occurs. This bit is also reset to 0 when the register is read.

0 = The drains are enabled for any output mode (unless overridden by the alternate function).
1 = The drain of the associated pin is disabled (open-drain mode).

Port A–C High Drive Enable Sub-Registers

The Port A–C High Drive Enable sub-register (Table 23) is accessed through the Port A–C Control register by writing 04H to the Port A–C Address register. Setting the bits in the Port A–C High Drive Enable sub-registers to 1 configures the specified port pins for high current output drive operation. The Port A–C High Drive Enable sub-register affects the pins directly and, as a result, alternate functions are also affected.

Table 23. Port A–C High Drive Enable Sub-Registers (PxHDE)

BITS	7	6	5	4	3	2	1	0
FIELD	PHDE7	PHDE6	PHDE5	PHDE4	PHDE3	PHDE2	PHDE1	PHDE0
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	If 04H in Port A–C Address Register, accessible through the Port A–C Control Register							

PHDE[7:0]—Port High Drive Enabled.
0 = The Port pin is configured for standard output current drive.
1 = The Port pin is configured for high output current drive.

Port A–C Stop Mode Recovery Source Enable Sub-Registers

The Port A–C Stop Mode Recovery Source Enable sub-register (Table 24) is accessed through the Port A–C Control register by writing 05H to the Port A–C Address register. Setting the bits in the Port A–C Stop Mode Recovery Source Enable sub-registers to 1 configures the specified Port pins as a Stop Mode Recovery source. During STOP mode, any logic transition on a Port pin enabled as a Stop Mode Recovery source initiates Stop Mode Recovery.

Table 24. Port A–C Stop Mode Recovery Source Enable Sub-Registers (PxSMRE)

BITS	7	6	5	4	3	2	1	0
FIELD	PSMRE7	PSMRE6	PSMRE5	PSMRE4	PSMRE3	PSMRE2	PSMRE1	PSMRE0
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	If 05H in Port A–C Address Register, accessible through the Port A–C Control Register							

Table 46. Interrupt Edge Select Register (IRQES)

BITS	7	6	5	4	3	2	1	0
FIELD	IES7	IES6	IES5	IES4	IES3	IES2	IES1	IES0
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	FCDH							

IES*x*—Interrupt Edge Select *x*
0 = An interrupt request is generated on the falling edge of the PA*x* input or PDx
1 = An interrupt request is generated on the rising edge of the PA*x* input PDx
where *x* indicates the specific GPIO port pin number (0 through 7)

Shared Interrupt Select Register

The Shared Interrupt Select (IRQSS) register (Table 47) determines the source of the PADxS interrupts. The Shared Interrupt Select register selects between Port A and alternate sources for the individual interrupts.

Because these shared interrupts are edge-triggered, it is possible to generate an interrupt just by switching from one shared source to another. For this reason, an interrupt must be disabled before switching between sources.

Table 47. Shared Interrupt Select Register (IRQSS)

BITS	7	6	5	4	3	2	1	0
FIELD	Reserved	PA6CS	Reserved					
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	FCEH							

PA6CS—PA6/Comparator Selection
0 = PA6 is used for the interrupt for PA6CS interrupt request
1 = The Comparator is used for the interrupt for PA6CS interrupt request

Reserved—Must be 0

Interrupt Control Register

The Interrupt Control (IRQCTL) register (Table 48) contains the master enable bit for all interrupts.

Reserved—0 when read

FSTAT—Flash Controller Status
000000 = Flash Controller locked
000001 = First unlock command received (73H written)
000010 = Second unlock command received (8CH written)
000011 = Flash Controller unlocked

000100 = Sector protect register selected

001xxx = Program operation in progress
010xxx = Page erase operation in progress
100xxx = Mass erase operation in progress

Flash Page Select Register

The Flash Page Select (FPS) register shares address space with the Flash Sector Protect Register. Unless the Flash controller is unlocked and written with 5EH, writes to this address target the Flash Page Select Register.

The register is used to select one of the eight available Flash memory pages to be programmed or erased. Each Flash Page contains 512 bytes of Flash memory. During a Page Erase operation, all Flash memory having addresses with the most significant 7-bits given by FPS[6:0] are chosen for program/erase operation.

Table 81. Flash Page Select Register (FPS)

BITS	7	6	5	4	3	2	1	0
FIELD	INFO_EN	PAGE						
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	FF9H							

INFO_EN—Information Area Enable

0 = Information Area us not selected

1 = Information Area is selected. The Information Area is mapped into the Program Memory address space at addresses FE00H through FFFFH.

PAGE—Page Select
This 7-bit field identifies the Flash memory page for Page Erase and page unlocking. Program Memory Address[15:9] = PAGE[6:0]. For the Z8F04x3 devices, the upper 4 bits must always be 0. For the Z8F02x3 devices, the upper 5 bits must always be 0. For the Z8F01x3 devices, the upper 6 bits must always be 0.

Flash Sector Protect Register

The Flash Sector Protect (FPROT) register is shared with the Flash Page Select Register. When the Flash Control Register is written with 73H followed by 5EH, the next write to this address targets the Flash Sector Protect Register. In all other cases, it targets the Flash Page Select Register.

This register selects one of the 8 available Flash memory sectors to be protected. The reset state of each Sector Protect bit is an unprotected state. After a sector is protected by setting its corresponding register bit, it cannot be unprotected (the register bit cannot be cleared) without powering down the device.

Table 82. Flash Sector Protect Register (FPROT)

BITS	7	6	5	4	3	2	1	0
FIELD	SPROT7	SPROT6	SPROT5	SPROT4	SPROT3	SPROT2	SPROT1	SPROT0
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	FF9H							

SPROT7-SPROT0—Sector Protection
Each bit corresponds to a 512 bytes Flash sector. For the Z8F08x3 devices, the upper 3 bits must be zero. For the Z8F04x3 devices all bits are used. For the Z8F02x3 devices, the upper 4 bits are unused. For the Z8F01x3 devices, the upper 6 bits are unused.

Flash Frequency High and Low Byte Registers

The Flash Frequency High (FFREQH) and Low Byte (FFREQL) registers combine to form a 16-bit value, FFREQ, to control timing for Flash program and erase operations. The 16-bit binary Flash Frequency value must contain the system clock frequency (in kHz) and is calculated using the following equation:

$$FFREQ[15:0] = \{FFREQH[7:0],FFREQL[7:0]\} = \frac{\text{System Clock Frequency}}{1000}$$

Caution: *The Flash Frequency High and Low Byte registers must be loaded with the correct value to ensure proper operation of the device. Also, Flash programming and erasure is not supported for system clock frequencies below 20 kHz or above 20 MHz.*

Operation

The following sections describes the operation of OCD.

OCD Interface

The OCD uses the DBG pin for communication with an external host. This one-pin interface is a bidirectional open-drain interface that transmits and receives data. Data transmission is half-duplex, in that transmit and receive cannot occur simultaneously. The serial data on the DBG pin is sent using the standard asynchronous data format defined in RS-232. This pin creates an interface from the Z8 Encore! XP F0823 Series products to the serial port of a host PC using minimal external hardware.Two different methods for connecting the DBG pin to an RS-232 interface are displayed in Figure 23 and Figure 24. The recommended method is the buffered implementation depicted in Figure 24. The DBG pin has a internal pull-up resistor which is sufficient for some applications (for more details on the pull-up current, see Electrical Characteristics on page 193). For OCD operation at higher data rates or in noisy systems, an external pull-up resistor is recommended.

Caution: *For operation of the OCD, all power pins (V_{DD} and AV_{DD}) must be supplied with power, and all ground pins (V_{SS} and AV_{SS}) must be properly grounded. The DBG pin is open-drain and may require an external pull-up resistor to ensure proper operation.*

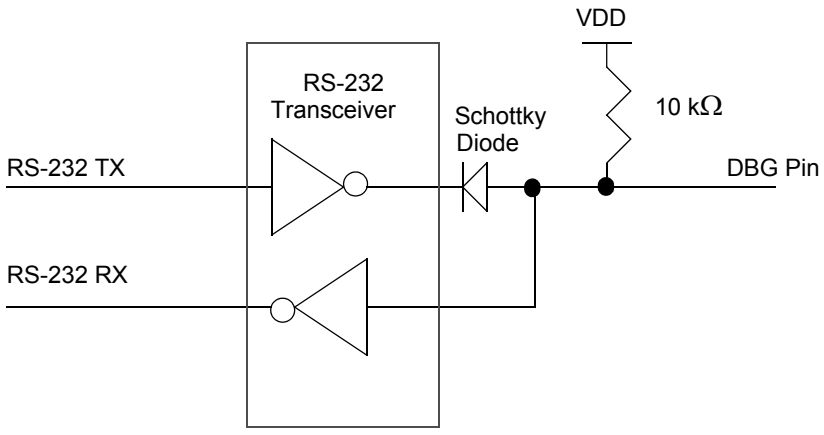


Figure 23. Interfacing the On-Chip Debugger's DBG Pin with an RS-232 Interface (1)

On-Chip Debugger Commands

The host communicates to the OCD by sending OCD commands using the DBG interface. During normal operation, only a subset of the OCD commands are available. In DEBUG mode, all OCD commands become available unless the user code and control registers are protected by programming the Flash Read Protect Option bit (FRP). The Flash Read Protect Option bit prevents the code in memory from being read out of Z8 Encore! XP® F0823 Series products. When this option is enabled, several of the OCD commands are disabled. Table 99 on page 162 is a summary of the OCD commands. Each OCD command is described in further detail in the bulleted list following this table. Table 99 on page 162 also indicates those commands that operate when the device is not in DEBUG mode (normal operation) and those commands that are disabled by programming the Flash Read Protect Option bit.

Debug Command	Command Byte	Enabled when NOT in DEBUG mode?	Disabled by Flash Read Protect Option Bit
Read OCD Revision	00H	Yes	–
Reserved	01H	–	–
Read OCD Status Register	02H	Yes	–
Read Runtime Counter	03H	–	–
Write OCD Control Register	04H	Yes	Cannot clear DBGMODE bit.
Read OCD Control Register	05H	Yes	–
Write Program Counter	06H	–	Disabled.
Read Program Counter	07H	–	Disabled.
Write Register	08H	–	Only writes of the Flash Memory Control registers are allowed. Additionally, only the Mass Erase command is allowed to be written to the Flash Control register.
Read Register	09H	–	Disabled.
Write Program Memory	0AH	–	Disabled.
Read Program Memory	0BH	–	Disabled.
Write Data Memory	0CH	–	Yes.
Read Data Memory	0DH	–	–
Read Program Memory CRC	0EH	–	–
Reserved	0FH	–	–
Step Instruction	10H	–	Disabled.

is not in DEBUG mode or if the Flash Read Protect Option bit is enabled, the data is discarded.

```
DBG ← 0AH
DBG ← Program Memory Address[15:8]
DBG ← Program Memory Address[7:0]
DBG ← Size[15:8]
DBG ← Size[7:0]
DBG ← 1-65536 data bytes
```

- **Read Program Memory (0BH)**—The Read Program Memory command reads data from Program Memory. This command is equivalent to the LDC and LDCI instructions. Data can be read 1–65536 bytes at a time (65536 bytes can be read by setting size to 0). If the device is not in DEBUG mode or if the Flash Read Protect Option Bit is enabled, this command returns FFH for the data.

```
DBG ← 0BH
DBG ← Program Memory Address[15:8]
DBG ← Program Memory Address[7:0]
DBG ← Size[15:8]
DBG ← Size[7:0]
DBG → 1-65536 data bytes
```

- **Write Data Memory (0CH)**—The Write Data Memory command writes data to Data Memory. This command is equivalent to the LDE and LDEI instructions. Data can be written 1–65536 bytes at a time (65536 bytes can be written by setting size to 0). If the device is not in DEBUG mode or if the Flash Read Protect Option Bit is enabled, the data is discarded.

```
DBG ← 0CH
DBG ← Data Memory Address[15:8]
DBG ← Data Memory Address[7:0]
DBG ← Size[15:8]
DBG ← Size[7:0]
DBG ← 1-65536 data bytes
```

- **Read Data Memory (0DH)**—The Read Data Memory command reads from Data Memory. This command is equivalent to the LDE and LDEI instructions. Data can be read 1 to 65536 bytes at a time (65536 bytes can be read by setting size to 0). If the device is not in DEBUG mode, this command returns FFH for the data.

```
DBG ← 0DH
DBG ← Data Memory Address[15:8]
DBG ← Data Memory Address[7:0]
DBG ← Size[15:8]
DBG ← Size[7:0]
DBG → 1-65536 data bytes
```

Table 115. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	Address Mode src	Opcode(s) (Hex)	Flags C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
XOR dst, src	dst ← dst XOR src	r	r	B2	–	*	*	0	–	–	2	3
		r	Ir	B3							2	4
		R	R	B4							3	3
		R	IR	B5							3	4
		R	IM	B6							3	3
		IR	IM	B7							3	4
XORX dst, src	dst ← dst XOR src	ER	ER	B8	–	*	*	0	–	–	4	3
		ER	IM	B9							4	3
Flags Notation:	* = Value is a function of the result of the operation. – = Unaffected X = Undefined				0 = Reset to 0 1 = Set to 1							

Table 117. Absolute Maximum Ratings (Continued)

Parameter	Minimum	Maximum	Units	Notes
Maximum current into V_{DD} or out of V_{SS}		125	mA	

Operating temperature is specified in DC Characteristics.
1. This voltage applies to all pins except the following: V_{DD}, AV_{DD}, pins supporting analog input (Port B[5:0], Port C[2:0]) and pins supporting the crystal oscillator (PA0 and PA1). On the 8-pin packages, this applies to all pins but V_{DD}.
2. This voltage applies to pins on the 20/28 pin packages supporting analog input (Port B[5:0], Port C[2:0]) and pins supporting the crystal oscillator (PA0 and PA1).

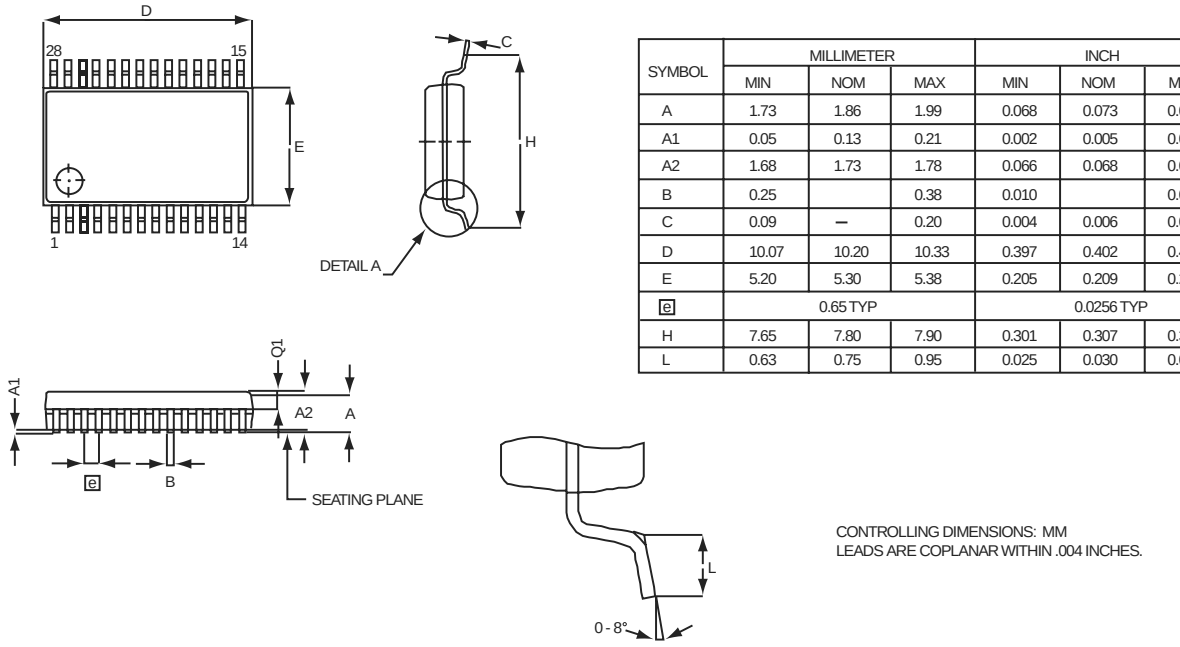
DC Characteristics

Table 118 lists the DC characteristics of the Z8 Encore! XP® F0823 Series products. All voltages are referenced to V_{SS}, the primary system ground.

Table 118. DC Characteristics

		T_A = -40 °C to +105 °C (unless otherwise specified)				
Symbol	Parameter	Minimum	Typical	Maximum	Units	Conditions
V_{DD}	Supply Voltage	2.7	–	3.6	V	
V_{IL1}	Low Level Input Voltage	-0.3	–	0.3*V_{DD}	V	
V_{IH1}	High Level Input Voltage	0.7*V_{DD}	–	5.5	V	For all input pins without analog or oscillator function. For all signal pins on the 8-pin devices. Programmable pull-ups must also be disabled.
V_{IH2}	High Level Input Voltage	0.7*V_{DD}	–	V_{DD}+0.3	V	For those pins with analog or oscillator function (20-/28-pin devices only), or when programmable pull-ups are enabled.
V_{OL1}	Low Level Output Voltage	–	–	0.4	V	I_{OL} = 2 mA; V_{DD} = 3.0 V High Output Drive disabled.
V_{OH1}	High Level Output Voltage	2.4	–	–	V	I_{OH} = -2 mA; V_{DD} = 3.0 V High Output Drive disabled.
V_{OL2}	Low Level Output Voltage	–	–	0.6	V	I_{OL} = 20 mA; V_{DD} = 3.3 V High Output Drive enabled.

Figure 42 displays the 28-pin Small Shrink Outline Package (SSOP) available for Z8 Encore! XP F0823 Series devices.



SYMBOL	MILLIMETER			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.73	1.86	1.99	0.068	0.073	0.078
A1	0.05	0.13	0.21	0.002	0.005	0.008
A2	1.68	1.73	1.78	0.066	0.068	0.070
B	0.25		0.38	0.010		0.015
C	0.09	–	0.20	0.004	0.006	0.008
D	10.07	10.20	10.33	0.397	0.402	0.407
E	5.20	5.30	5.38	0.205	0.209	0.212
e	0.65 TYP			0.0256 TYP		
H	7.65	7.80	7.90	0.301	0.307	0.311
L	0.63	0.75	0.95	0.025	0.030	0.037

Figure 42. 28-Pin Small Shrink Outline Package (SSOP)

Part Number	Flash	RAM	I/O Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Description
Z8 Encore! XP with 2 KB Flash, 10-Bit Analog-to-Digital Converter								
Standard Temperature: 0 °C to 70 °C								
Z8F0223PB005SC	2 KB	512 B	6	12	2	4	1	PDIP 8-pin package
Z8F0223QB005SC	2 KB	512 B	6	12	2	4	1	QFN 8-pin package
Z8F0223SB005SC	2 KB	512 B	6	12	2	4	1	SOIC 8-pin package
Z8F0223SH005SC	2 KB	512 B	16	18	2	7	1	SOIC 20-pin package
Z8F0223HH005SC	2 KB	512 B	16	18	2	7	1	SSOP 20-pin package
Z8F0223PH005SC	2 KB	512 B	16	18	2	7	1	PDIP 20-pin package
Z8F0223SJ005SC	2 KB	512 B	22	18	2	8	1	SOIC 28-pin package
Z8F0223HJ005SC	2 KB	512 B	22	18	2	8	1	SSOP 28-pin package
Z8F0223PJ005SC	2 KB	512 B	22	18	2	8	1	PDIP 28-pin package
Extended Temperature: -40 °C to 105 °C								
Z8F0223PB005EC	2 KB	512 B	6	12	2	4	1	PDIP 8-pin package
Z8F0223QB005EC	2 KB	512 B	6	12	2	4	1	QFN 8-pin package
Z8F0223SB005EC	2 KB	512 B	6	12	2	4	1	SOIC 8-pin package
Z8F0223SH005EC	2 KB	512 B	16	18	2	7	1	SOIC 20-pin package
Z8F0223HH005EC	2 KB	512 B	16	18	2	7	1	SSOP 20-pin package
Z8F0223PH005EC	2 KB	512 B	16	18	2	7	1	PDIP 20-pin package
Z8F0223SJ005EC	2 KB	512 B	22	18	2	8	1	SOIC 28-pin package
Z8F0223HJ005EC	2 KB	512 B	22	18	2	8	1	SSOP 28-pin package
Z8F0223PJ005EC	2 KB	512 B	22	18	2	8	1	PDIP 28-pin package
Replace C with G for Lead-Free Packaging								

Index

Symbols

Numerics

A

B

C

Customer Support

For answers to technical questions about the product, documentation, or any other issues with Zilog's offerings, please visit Zilog's Knowledge Base at http://www.zilog.com/kb.

For any comments, detail technical questions, or reporting problems, please visit Zilog's Technical Support at http://support.zilog.com.